











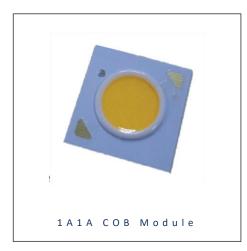




- ► COB Module
- ► 15.85x15.85x1.65mm
- ► Natural White 5000K

N0W63M20









#### **FEATURES:**

- Package: Top View COB Light Engine Module
- Forward Current: 330~600mA
  Forward Voltage (typ.): 35.4V
- Luminous Flux (typ.): 1445lm@330mA
- Colour: Natural White
- Colour Temperature (CCT): 5000K
- Viewing Angle: 120°
- Materials:
  - Die: InGaN
  - Resin: Silicon (Yellow Diffused)
  - Package: MCPCB
- Operating Temperature: -40~+100°C
  Storage Temperature: -40~+120°C
- Grouping Parameters:
  - Forward Voltage
  - Luminous Flux
  - CIE Chromaticity
- MSL Level: 3 according to J-STD020
- Packing: 54pcs/tray; 270pcs/carton

## **APPLICATIONS:**

- Commercial Lighting
- Tunnel Light
- Spotlight
- General Lighting



## **CHARACTERISTICS:**

# Absolute Maximum Characteristics (T<sub>a</sub>=25°C)

Parameter	Symbol	Ratings	Unit	
DC Forward Current	l <sub>F</sub>	600	mA	
Power Dissipation	P <sub>D</sub>	21.72	W	
Junction Temperature *	Tj	125	°C	
Operating Temperature	T <sub>OPR</sub>	-40~+100	°C	
Storage Temperature	T <sub>STG</sub>	-40~+120	°C	
Thermal Resistance	R <sub>thj-sp</sub>	0.6	°C/W	
Colour Bondoring Indox (CBI)	R9	min.83		
Colour Rendering Index (CRI)	Ra	min.95		

 $<sup>^{*}</sup>$  Rth j-sp is the thermal resistance from LED junction to solder point on MCPCB with electrical power.

## Electrical & Optical Characteristics (T<sub>a</sub>=25°C)

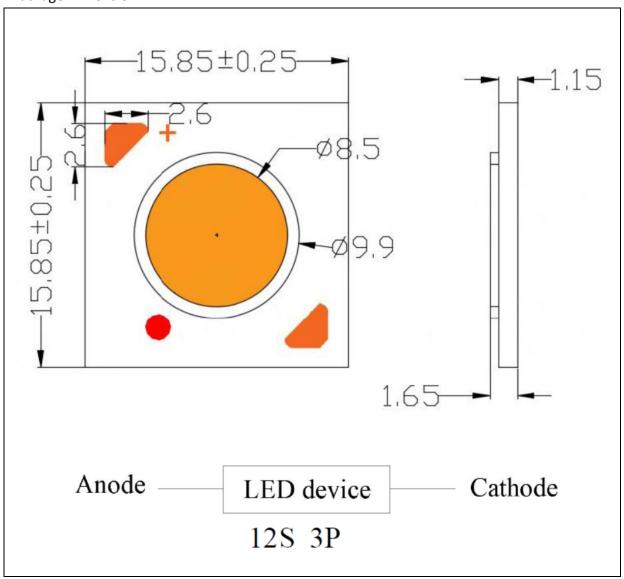
Parameter	Symbol	Values			Linit	Test	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition	
Forward Voltage	V <sub>F</sub>	33.0	35.4		V	I <sub>F</sub> =330mA	
Luminous Flux	Ф۷	1344	1445	1590	lm	I <sub>F</sub> =330mA	
Chromaticity Coordinates	Х		0.3447			I⊧=330mA	
	Υ		0.3553				
Colour Temperature	ССТ		5000		К	I <sub>F</sub> =330mA	
Viewing Angle	2θ <sub>1/2</sub>		120		deg	I <sub>F</sub> =330mA	

<sup>1.</sup> Luminous flux ( $\Phi_V$ )  $\pm 10\%$ , Forward Voltage ( $V_F$ )  $\pm 0.1V$ , CRI  $\pm 2$ 



## **OUTLINE DIMENSION:**

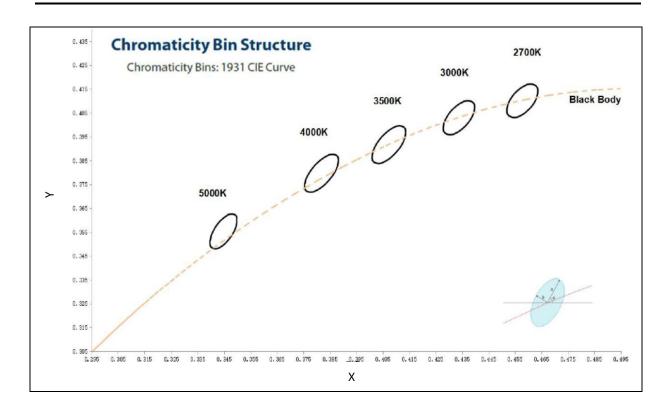
## Package Dimension:



- 1. All dimensions are in millimetre (mm).
- 2. Tolerance ±0.2mm, unless otherwise noted.



## **CIE CHROMATICITY DIAGRAM:**

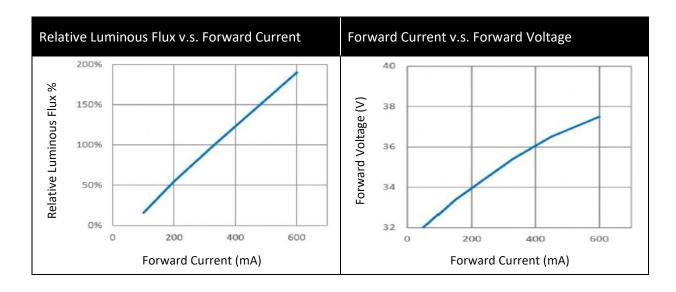


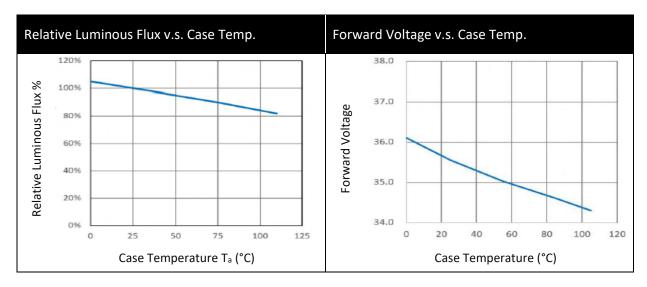
## Chromaticity Coordinates Classifications (I<sub>F</sub> = 330mA):

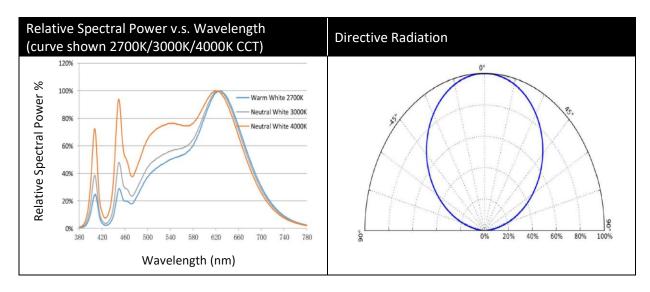
/	Code	Centre		Radius		Angle
a / )	Code	Х	X Y a	b	Φ	
<b>В</b> Ф	50M3 (3 STEP)	0.3447	0.3553	0.008220	0.003540	59.60



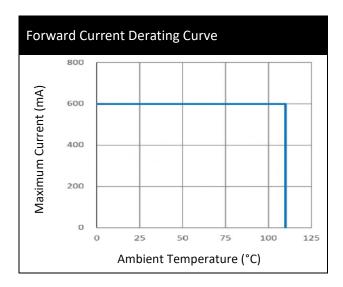
## **ELECTRO-OPTICAL CHARACTERISTICS:**













#### **PRECAUTIONS OF USE:**

#### Storage:

It is recommended to store the products in the following conditions:

Humidity: 60% R.H. Max.

• Temperature: 5°C~30°C (41°F ~86°F).

Shelf life in sealed bag: 12 months at 5°C~30°C and <60% R.H.

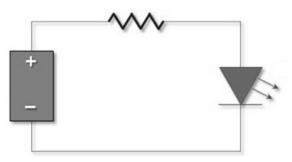
Once the package is opened, the products should be used within a week. Otherwise, they should be kept in a damp-proof box with descanting agent <10% R.H. and apply baking before use.

#### Thermal Management:

Thermal management is a key factor affecting the life of LEDs. The life span of LEDs will reduce with the increase of junction temperature. Please make sure that the temperature of Tj is lower than 125°C during application.

The silicone casting will begin to degrade at 180°C and shall be crake in a few days. Please avoid silicone surface temperature higher than 180°C.

#### **Testing Circuit:**



Must apply resistor(s) for protection (over current proof).

#### **Chemical Corrosion:**

COB is packaged with soft silicone. Its design is not waterproof, thus please do not dip the COB into water directly. Please avoid silicone contact with sulfur dioxide, sulfuric acid, concentrated hydrochloric acid, and keep dry and sealed during storage.

### ESD (Electrostatic Discharge):

Static Electricity or power surge will damage the LED. Use of a conductive wrist band or anti-electrosatic glove is recommended when handing the LED all time. All devices, equipment, machinery, work tables, and storage racks must be properly grounded.

In the events of manual working in process, make sure the devices are well protected from ESD at any time.



# **REVISION RECORD:**

Version	Date	Summary of Revision
A1.0	25/11/2022	Datasheet set-up.
A1.1	17/04/2025	Update specifications.